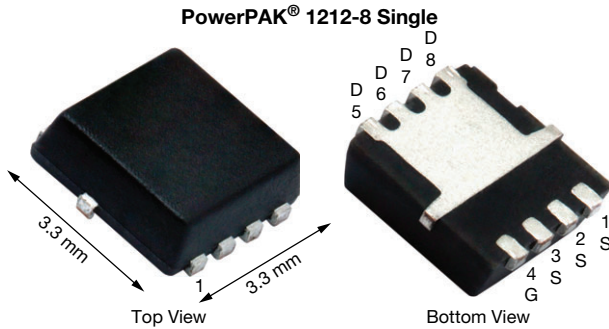


N-Channel 20 V (D-S) MOSFET



FEATURES

- TrenchFET® Gen IV power MOSFET
- Less than 1.1 mΩ in a package footprint of 10.89 mm²
- 2.5 V rated R_{DS(on)}
- Optimized Q_g, Q_{gd}, and Q_{gd}/Q_{gs} ratio reduce switching related power loss
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

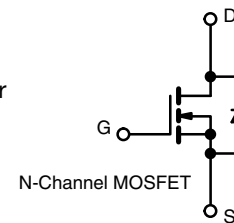


RoHS
COMPLIANT
HALOGEN
FREE

PRODUCT SUMMARY	
V _{DS} (V)	20
R _{DS(on)} max. (Ω) at V _{GS} = 10 V	0.00110
R _{DS(on)} max. (Ω) at V _{GS} = 4.5 V	0.00145
R _{DS(on)} max. (Ω) at V _{GS} = 2.5 V	0.00420
Q _g typ. (nC)	18.2
I _D (A)	162 ^a
Configuration	Single

APPLICATIONS

- Synchronous rectification
- Synchronous buck converter
- Battery management
- Load switching



ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSA40DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	V _{DS}	20	V	
Gate-source voltage	V _{GS}	+12 / -8	V	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C	162	A	
	T _C = 70 °C	129		
	T _A = 25 °C	43.7 ^{b, c}		
	T _A = 70 °C	35 ^{b, c}		
Pulsed drain current (t = 100 μs)	I _{DM}	150	A	
Continuous source-drain diode current	T _C = 25 °C	47	A	
	T _A = 25 °C	3.3 ^{b, c}		
Single pulse avalanche current	L = 0.1 mH	20	A	
Single pulse avalanche energy	E _{AS}	20	mJ	
Maximum power dissipation	T _C = 25 °C	52	W	
	T _C = 70 °C	33		
	T _A = 25 °C	3.7 ^{b, c}		
	T _A = 70 °C	2.4 ^{b, c}		
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^c		260	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	R _{thJA}	24	33	°C/W
Maximum junction-to-case (drain)	R _{thJF}	1.9	2.4	

Notes

- Package limited
- Surface mounted on 1" x 1" FR4 board
- t = 10 s
- See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 81 °C/W
- T_C = 25 °C



SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	20	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	$I_D = 10\text{ mA}$	-	18	-	mV/ $^\circ\text{C}$
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250\text{ }\mu\text{A}$	-	-3.6	-	
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	0.6	-	1.5	V
Gate-source leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = +12 / -8\text{ V}$	-	-	100	nA
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}$	-	-	1	μA
		$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}, T_J = 70\text{ }^\circ\text{C}$	-	-	15	
On-state drain current ^a	$I_{D(on)}$	$V_{DS} \geq 10\text{ V}, V_{GS} = 10\text{ V}$	40	-	-	A
Drain-source on-state resistance ^a	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	-	0.00092	0.00110	Ω
		$V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$	-	0.00120	0.00145	
		$V_{GS} = 2.5\text{ V}, I_D = 10\text{ A}$	-	0.00320	0.00420	
Forward transconductance ^a	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 10\text{ A}$	-	60	-	S
Dynamic ^b						
Input capacitance	C_{ISS}	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	-	3415	-	μF
Output capacitance	C_{OSS}		-	1290	-	
Reverse transfer capacitance	C_{RSS}		-	72	-	
Total gate charge	Q_g	$V_{DS} = 10\text{ V}, V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	-	35.2	53	nC
		$V_{DS} = 10\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$	-	18.2	27.5	
Gate-source charge	Q_{gs}		-	7.3	-	
Gate-drain charge	Q_{gd}		-	3.6	-	
Gate resistance	R_g	$f = 1\text{ MHz}$	0.4	0.85	1.4	Ω
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 10\text{ V}, R_L = 1\text{ }\Omega, I_D \cong 10\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\text{ }\Omega$	-	20	40	ns
Rise time	t_r		-	13	26	
Turn-off delay time	$t_{d(off)}$		-	40	80	
Fall time	t_f		-	10	20	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 10\text{ V}, R_L = 1\text{ }\Omega, I_D \cong 10\text{ A}, V_{GEN} = 4.5\text{ V}, R_g = 1\text{ }\Omega$	-	12	24	
Rise time	t_r		-	5	10	
Turn-off delay time	$t_{d(off)}$		-	34	68	
Fall time	t_f		-	6	10	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	$T_C = 25\text{ }^\circ\text{C}$	-	-	47	A
Pulse diode forward current	I_{SM}		-	-	150	
Body diode voltage	V_{SD}	$I_S = 5\text{ A}, V_{GS} = 0\text{ V}$	-	0.73	1.1	V
Body diode reverse recovery time	t_{rr}	$I_F = 10\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$	-	32	64	ns
Body diode reverse recovery charge	Q_{rr}		-	21	42	nC
Reverse recovery fall time	t_a		-	16	-	ns
Reverse recovery rise time	t_b		-	16	-	

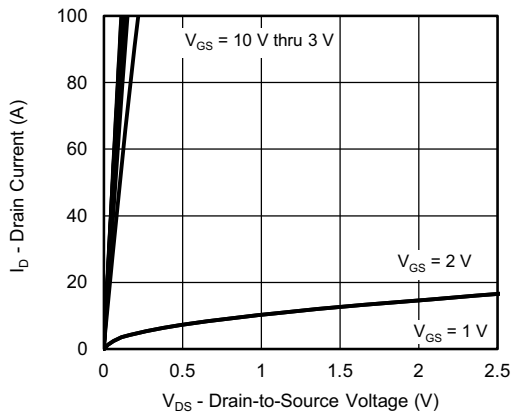
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
- b. Guaranteed by design, not subject to production testing

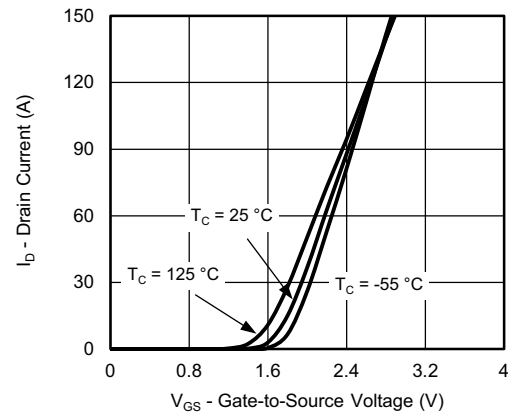
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



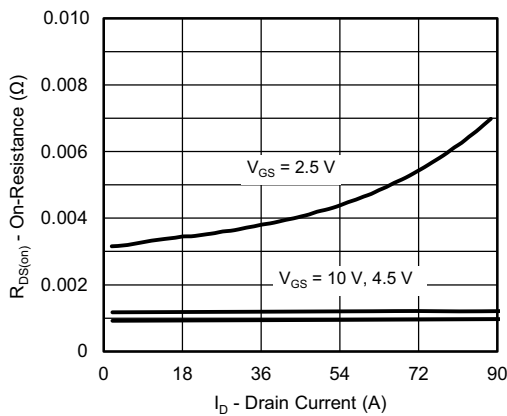
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



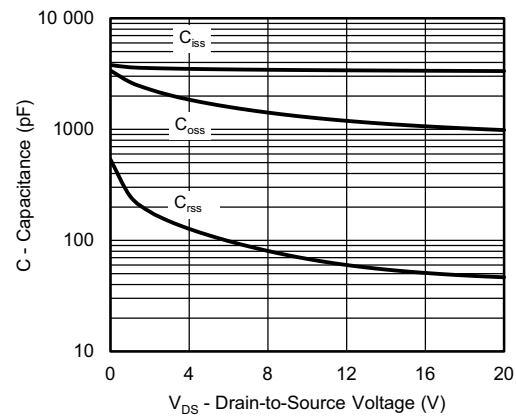
Output Characteristics



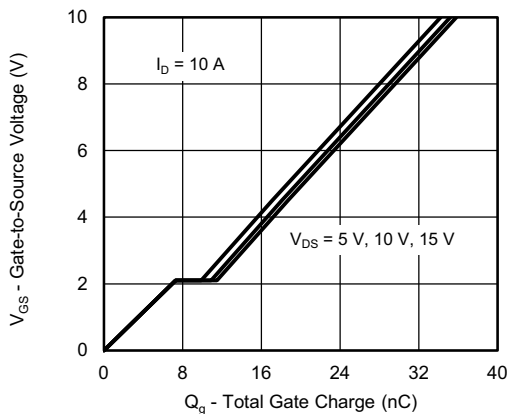
Transfer Characteristics



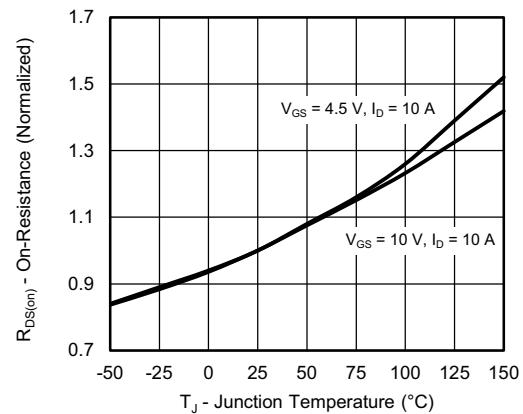
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



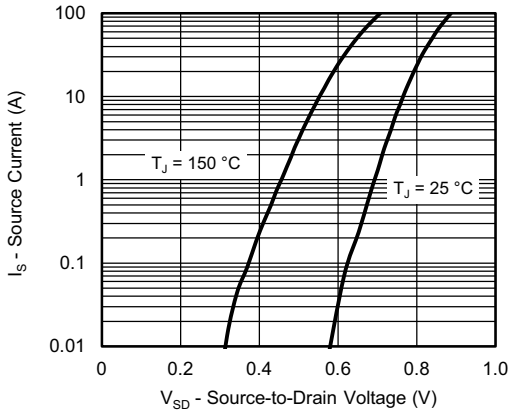
Gate Charge



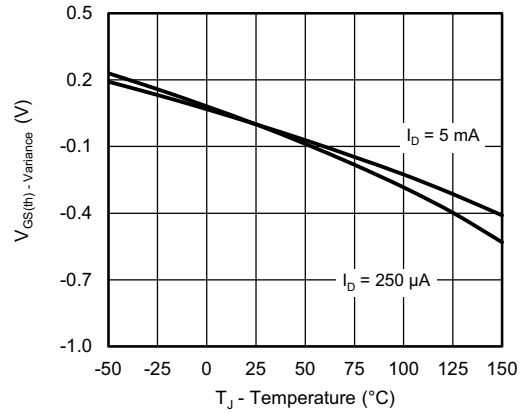
On-Resistance vs. Junction Temperature



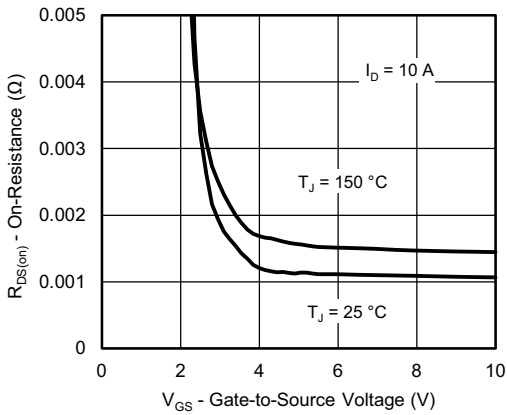
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



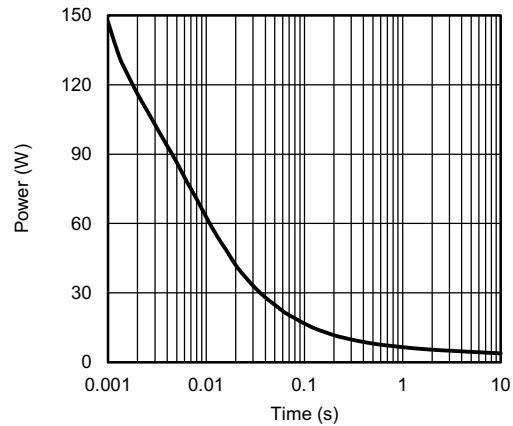
Source-Drain Diode Forward Voltage



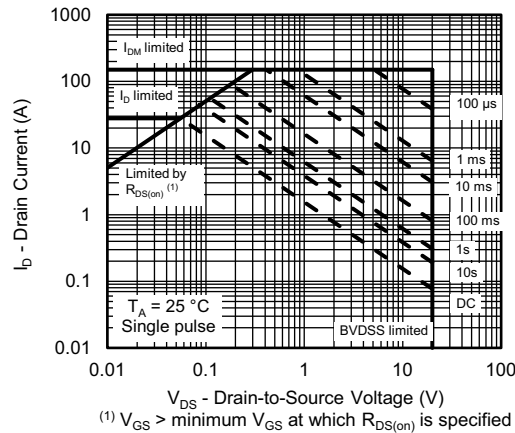
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



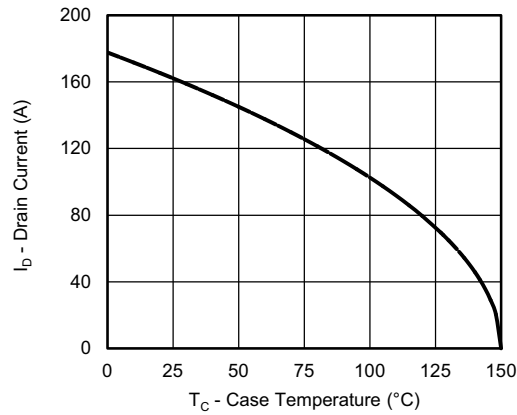
Single Pulse Power, Junction-to-Ambient



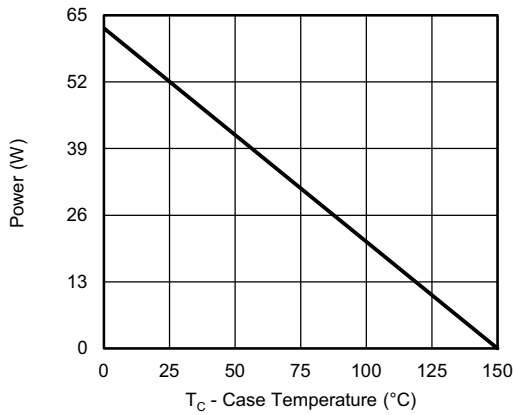
Safe Operating Area, Junction-to-Ambient



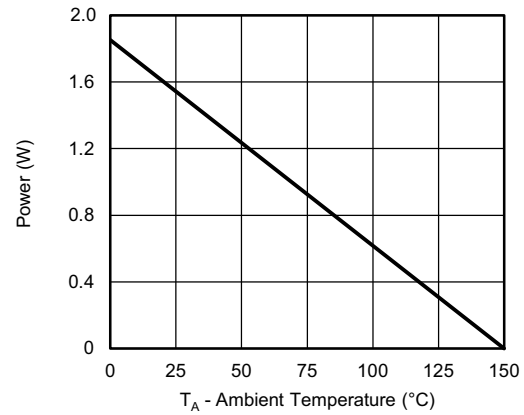
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



Power, Junction-to-Case



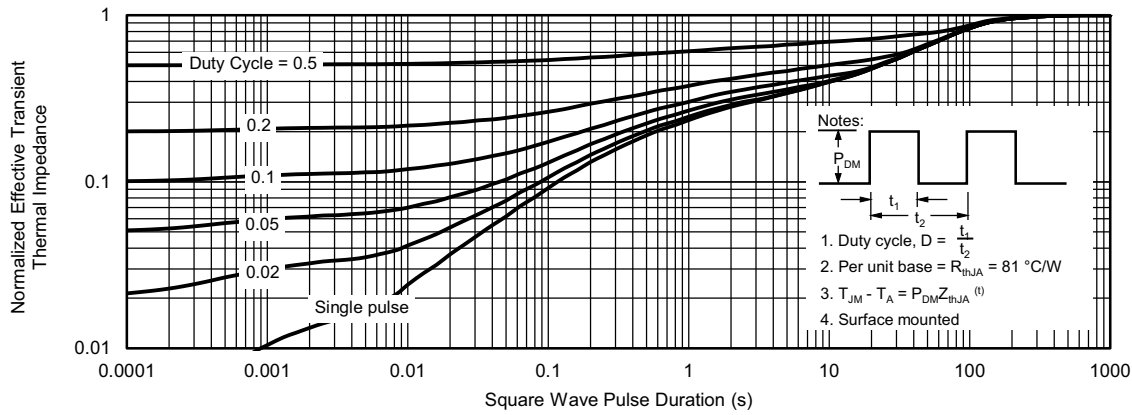
Power, Junction-to-Ambient

Note

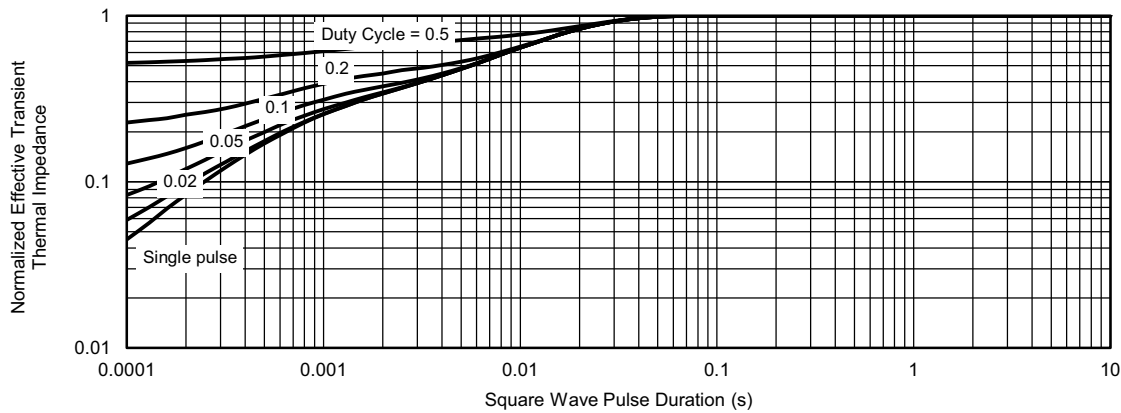
- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А